WHAT IS CLAIMED IS:

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1. A high energy plating process for static seals comprising:

supporting a predetermined quantity of metallic seals at non-sealing surface locations with the metallic seals disposed in series on a conveyor having a predetermined processing path; and

continuously moving the metallic seals on the conveyor in series through an electro-plating stage of the predetermined processing path to electro-deposit a metallic coating on the metallic seals using a high current density and a high chemical flow rate.

2. The process according to claim 1, further comprising

continuously moving the metallic seals on the conveyor in series through an initial cleaning stage of the predetermined processing path prior to moving the metallic seals through the electro-plating stage.

3. The process according to claim 2, further comprising

continuously moving the metallic seals on the conveyor in series through an initial rinsing stage of the predetermined processing path after moving the metallic seals through the cleaning stage and prior to moving the metallic seals through the electro-plating stage.

20 4. The process according to claim 3, further comprising

continuously moving the metallic seals on the conveyor in series through a final rinsing stage of the predetermined processing path after moving the metallic seals through the electro-plating stage.

5. The process according to claim 4, wherein

the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path includes

continuously moving the metallic seals on the conveyor in series through an under plating stage of the predetermined processing path, and

continuously moving the metallic seals on the conveyor in series through a top plating stage of the predetermined processing path.

6. The process according to claim 5, wherein

the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path includes

continuously moving the metallic seals on the conveyor in series through an intermediate rinsing stage of the predetermined processing path after moving the metallic seals through the under plating stage and prior to moving the metallic seals through the top-plating stage.

7. The process according to claim 3, wherein

the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path includes

continuously moving the metallic seals on the conveyor in series through an under plating stage of the predetermined processing path, and

continuously moving the metallic seals on the conveyor in series through a top plating stage of the predetermined processing path.

8. The process according to claim 7, wherein

the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path includes

continuously moving the metallic seals on the conveyor in series through an intermediate rinsing stage of the predetermined processing path after moving the metallic seals through the under plating stage and prior to moving the metallic seals through the top-plating stage.

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9. The process according to claim 1, wherein

the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path includes

continuously moving the metallic seals on the conveyor in series through an under plating stage of the predetermined processing path, and

continuously moving the metallic seals on the conveyor in series through a top plating stage of the predetermined processing path.

10. The process according to claim 9, wherein

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the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path includes

continuously moving the metallic seals on the conveyor in series through an intermediate rinsing stage of the predetermined processing path after moving the metallic seals through the under plating stage and prior to moving the metallic seals through the top-plating stage.

11. The process according to claim 9, wherein

the under plating stage includes at least one striking stage that is substantially shorter than said top plating stage.

12. The process according to claim 11, wherein

said top plating stage is at least about ten times longer than said at least one striking stage.

13. The process according to claim 1, wherein

the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path includes

continuously moving the metallic seals on the conveyor in series through at least two different plating stages of the predetermined processing path.

- 14. The process according to claim 1, wherein
- 25 the metallic seals are oriented vertically during the continuously moving of the metallic seals on the conveyor in series through the electro-plating stage of the predetermined processing path.
 - 15. The process according to claim 1, wherein

the process is a continuous high volume process electro-depositing the metallic coating on the metallic seals at a rate of at least about 5 seals per minute.

- 16. The process according to claim 1, wherein the metallic coating is a soft metallic coating.
- 17. The process according to claim 16, wherein
 the metallic coating includes at least one of tin, tin alloy, lead, gold, silver, silver alloy, nickel, copper and indium.
- The process according to claim 17, wherein
 the metallic seals are constructed of one of Stainless Steel, Inconel and Waspaloy

 prior to electro-depositing the metallic coating during the electro-plating stage of the predetermined processing path.
- 19. The process according to claim 1, wherein the metallic seals are constructed of one of Stainless Steel, Inconel and Waspaloy
 15 prior to electro-depositing the metallic coating during the electro-plating stage of the predetermined processing path.
- 20. The process according to claim 1, wherein the high current density used during the continuously moving of the metallic seals
 20 on the conveyor in series through the electro-plating stage of the predetermined processing path is between about 200 ASF and about 1000 ASF during at least a portion of the electro-plating stage.